THE DATASHEET OF

74LVC1G53DC

74LVC1G53

2-channel analog multiplexer/demultiplexer

Rev. 11 — 16 January 2018 Product data sheet

1 General description

The 74LVC1G53 is a low-power, low-voltage, high-speed, Si-gate CMOS device.

The 74LVC1G53 provides one analog multiplexer/demultiplexer with a digital select input (S), two independent inputs/outputs (Y0 and Y1), a common input/output (Z) and an active LOW enable input ($\overline{E}$). When pin $\overline{E}$ is HIGH, the switch is turned off.

Schmitt trigger action at the select and enable inputs makes the circuit tolerant of slower input rise and fall times across the entire V_{CC} range from 1.65 V to 5.5 V.

2 Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- Very low ON resistance:
  - 7.5 Ω (typical) at V_{CC} = 2.7 V
  - 6.5 Ω (typical) at V_{CC} = 3.3 V
  - 6 Ω (typical) at V_{CC} = 5 V
- Switch current capability of 32 mA
- High noise immunity
- CMOS low power consumption
- TTL interface compatibility at 3.3 V
- Latch-up performance meets requirements of JESD 78 Class I
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Control inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

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3 Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G53DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2
74LVC1G53DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
74LVC1G53GT	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm	SOT833-1
74LVC1G53GF	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm	SOT1089
74LVC1G53GM	-40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm	SOT902-2
74LVC1G53GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm	SOT1116
74LVC1G53GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm	SOT1203

4 Marking

Table 2. Marking codes

Type number	Marking code[1]
74LVC1G53DC	V53
74LVC1G53DP	V53
74LVC1G53GT	V53
74LVC1G53GF	V3
74LVC1G53GM	V53
74LVC1G53GN	V3
74LVC1G53GS	V3

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5 Functional diagram

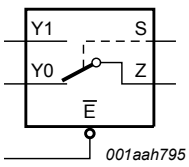


Figure 1. Logic symbol

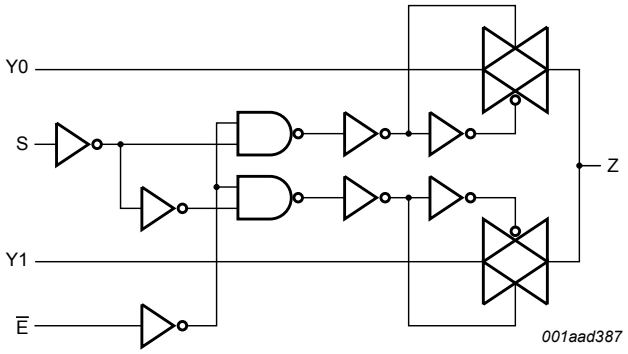


Figure 2. Logic diagram

6 Pinning information

6.1 Pinning

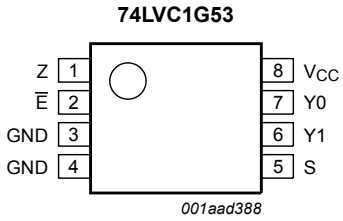
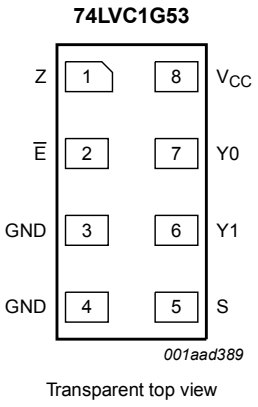


Figure 3. Pin configuration SOT505-2 and SOT765-1



Transparent top view

Figure 4. Pin configuration SOT833-1, SOT1089, SOT1116 and SOT1203

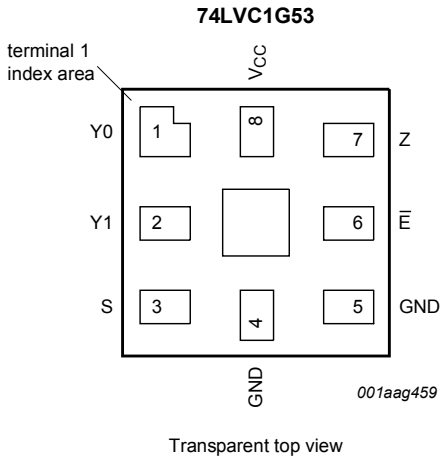


Figure 5. Pin configuration SOT902-2

6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT1116 and SOT1203	SOT902-2	
Z	1	7	common output or input
$\overline{E}$	2	6	enable input (active LOW)
GND	3	5	ground (0 V)
GND	4	4	ground (0 V)
S	5	3	select input
Y1	6	2	independent input or output
Y0	7	1	independent input or output
V_{CC}	8	8	supply voltage

7 Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Input		Channel on
S	$\overline{E}$	
L	L	Y0 to Z or Z to Y0
H	L	Y1 to Z or Z to Y1
X	H	Z (switch off)

8 Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+6.5	V
V_I	input voltage		[1]	-0.5	+6.5	V
I_{IK}	input clamping current	$V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V		-50	-	mA
I_{SK}	switch clamping current	$V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V		-	±50	mA
V_{SW}	switch voltage	enable and disable mode	[2]	-0.5	$V_{CC} + 0.5$	V
I_{SW}	switch current	$V_{SW} > -0.5$ V or $V_{SW} < V_{CC} + 0.5$ V		-	±50	mA
I_{CC}	supply current			-	100	mA
I_{GND}	ground current			-100	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[3]	-	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.
[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.
[3] For TSSOP8 packages: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K.
For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.
For XSON8 and XQFN8 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9 Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			1.65	5.5	V
V_I	input voltage			0	5.5	V
V_{SW}	switch voltage	enable and disable mode	[1]	0	V_{CC}	V
T_{amb}	ambient temperature			-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	[2]	-	20	ns/V
		V_{CC} = 2.7 V to 5.5 V	[2]	-	10	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.
[2] Applies to control signal levels.

10 Static characteristics

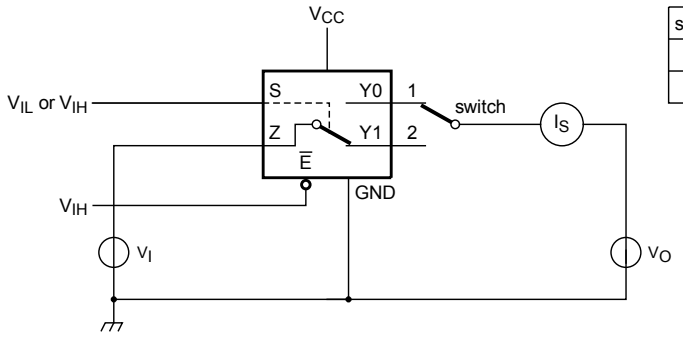
Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	T_{amb} = -40 °C to +85 °C			T_{amb} = -40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level input voltage	V_{CC} = 1.65 V to 1.95 V	0.65xV_{CC}	-	-	0.65xV_{CC}	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 3 V to 3.6 V	2.0	-	-	2.0	-	V
		V_{CC} = 4.5 V to 5.5 V	0.7xV_{CC}	-	-	0.7xV_{CC}	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	0.35xV_{CC}	-	0.35xV_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 3 V to 3.6 V	-	-	0.8	-	0.8	V
		V_{CC} = 4.5 V to 5.5 V	-	-	0.3xV_{CC}	-	0.3xV_{CC}	V
I_I	input leakage current	pin S and pin $\overline{E}$; V_I = 5.5 V or GND; V_{CC} = 0 V to 5.5 V [2]	-	±0.1	±1	-	±1	µA
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 5.5 V; see Figure 6 [2]	-	±0.1	±0.2	-	±0.5	µA
$I_{S(ON)}$	ON-state leakage current	V_{CC} = 5.5 V; see Figure 7 [2]	-	±0.1	±1	-	±2	µA
I_{CC}	supply current	V_I = 5.5 V or GND; V_{SW} = GND or V_{CC}; V_{CC} = 1.65 V to 5.5 V [2]	-	0.1	4	-	4	µA
ΔI_{CC}	additional supply current	pin S and pin $\overline{E}$; V_I = V_{CC} - 0.6 V; V_{SW} = GND or V_{CC}; V_{CC} = 5.5 V [2]	-	5	500	-	5 00	µA
C_I	input capacitance		-	2.5	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	6.0	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance		-	18	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C.
[2] These typical values are measured at V_{CC} = 3.3 V.

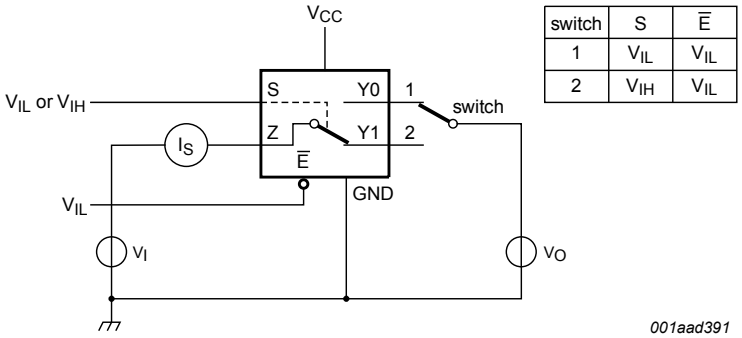
10.1 Test circuits



switch	S	$\overline{E}$
1	V_{IL}	V_{IH}
2	V_{IH}	V_{IH}

$V_I = V_{CC}$ or GND; V_O = GND or V_{CC}

Figure 6. Test circuit for measuring OFF-state leakage current



switch	S	$\overline{E}$
1	V_{IL}	V_{IL}
2	V_{IH}	V_{IL}

$V_I = V_{CC}$ or GND and V_O = open circuit

Figure 7. Test circuit for measuring ON-state leakage current

10.2 ON resistance

Table 8. ON resistance

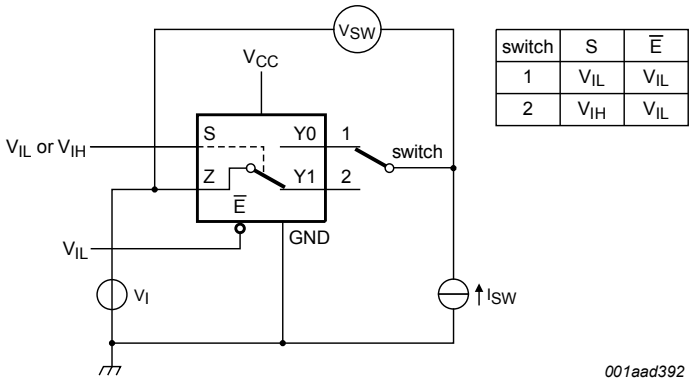
At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see Figure 9 to Figure 14.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$R_{ON(peak)}$	ON resistance (peak)	V_I = GND to V_{CC}; see Figure 8						
		I_{SW} = 4 mA; V_{CC} = 1.65 V to 1.95 V	-	34.0	130	-	195	Ω
		I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V	-	12.0	30	-	45	Ω
		I_{SW} = 12 mA; V_{CC} = 2.7 V	-	10.4	25	-	38	Ω
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	7.8	20	-	30	Ω
		I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V	-	6.2	15	-	23	Ω

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$R_{ON(rail)}$	ON resistance (rail)	V_I = GND; see Figure 8						
		I_{SW} = 4 mA; V_{CC} = 1.65 V to 1.95 V	-	8.2	18	-	27	Ω
		I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V	-	7.1	16	-	24	Ω
		I_{SW} = 12 mA; V_{CC} = 2.7 V	-	6.9	14	-	21	Ω
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	6.5	12	-	18	Ω
		I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V	-	5.8	10	-	15	Ω
		V_I = V_{CC}; see Figure 8						
		I_{SW} = 4 mA; V_{CC} = 1.65 V to 1.95 V	-	10.4	30	-	45	Ω
		I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V	-	7.6	20	-	30	Ω
		I_{SW} = 12 mA; V_{CC} = 2.7 V	-	7.0	18	-	27	Ω
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	6.1	15	-	23	Ω
		I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V	-	4.9	10	-	15	Ω
$R_{ON(flat)}$	ON resistance (flatness)	V_I = GND to V_{CC} [2]						
		I_{SW} = 4 mA; V_{CC} = 1.65 V to 1.95 V	-	26.0	-	-	-	Ω
		I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V	-	5.0	-	-	-	Ω
		I_{SW} = 12 mA; V_{CC} = 2.7 V	-	3.5	-	-	-	Ω
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	2.0	-	-	-	Ω
		I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V	-	1.5	-	-	-	Ω

[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC}.
[2] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

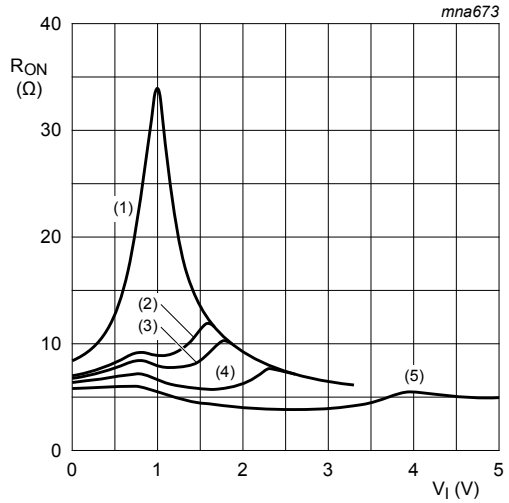
10.3 ON resistance test circuit and graphs



switch	S	$\overline{E}$
1	V_{IL}	V_{IL}
2	V_{IH}	V_{IL}

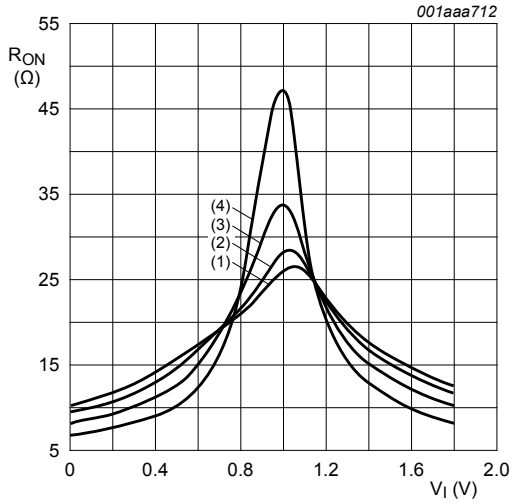
$R_{ON} = V_{SW} / I_{SW}$

Figure 8. Test circuit for measuring ON resistance



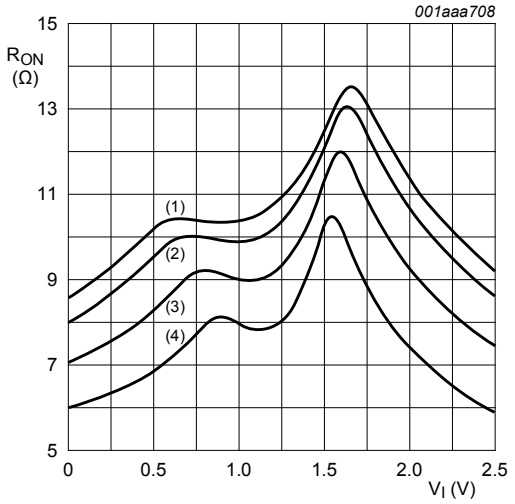
(1) V_{CC} = 1.8 V
(2) V_{CC} = 2.5 V
(3) V_{CC} = 2.7 V
(4) V_{CC} = 3.3 V
(5) V_{CC} = 5.0 V

Figure 9. Typical ON resistance as a function of input voltage; T_{amb} = 25 °C



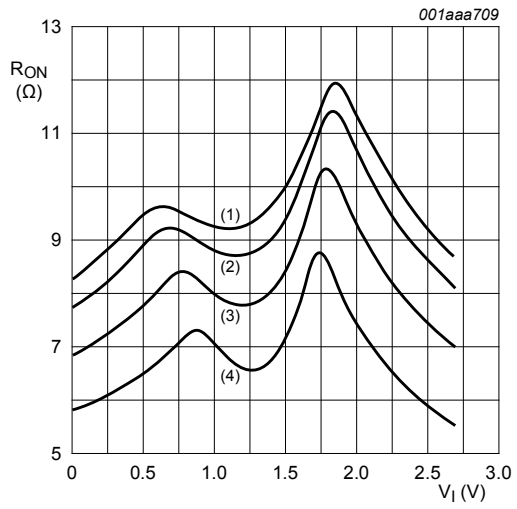
(1) T_{amb} = 125 °C
(2) T_{amb} = 85 °C
(3) T_{amb} = 25 °C
(4) T_{amb} = -40 °C

Figure 10. ON resistance as a function of input voltage; V_{CC} = 1.8 V



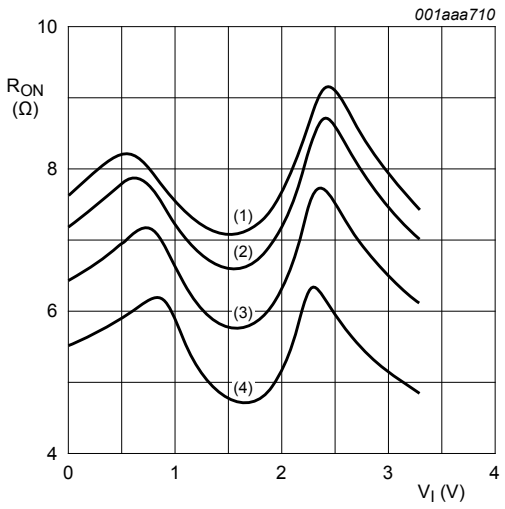
(1) T_{amb} = 125 °C
(2) T_{amb} = 85 °C
(3) T_{amb} = 25 °C
(4) T_{amb} = -40 °C

Figure 11. ON resistance as a function of input voltage; V_{CC} = 2.5 V



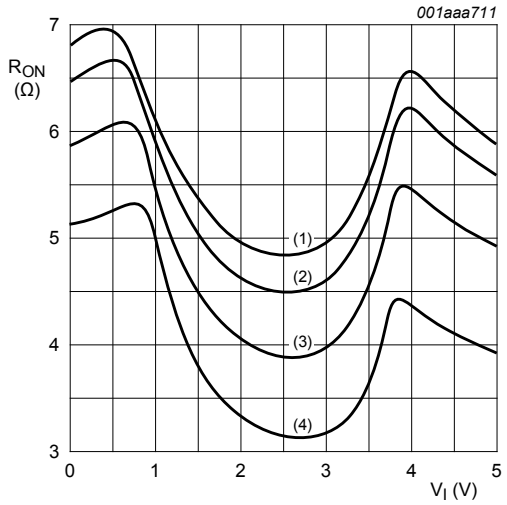
(1) T_{amb} = 125 °C
(2) T_{amb} = 85 °C
(3) T_{amb} = 25 °C
(4) T_{amb} = -40 °C

Figure 12. ON resistance as a function of input voltage; V_{CC} = 2.7 V



(1) T_{amb} = 125 °C
(2) T_{amb} = 85 °C
(3) T_{amb} = 25 °C
(4) T_{amb} = -40 °C

Figure 13. ON resistance as a function of input voltage; V_{CC} = 3.3 V



(1) T_{amb} = 125 °C
(2) T_{amb} = 85 °C
(3) T_{amb} = 25 °C
(4) T_{amb} = -40 °C

Figure 14. ON resistance as a function of input voltage; V_{CC} = 5.0 V

11 Dynamic characteristics

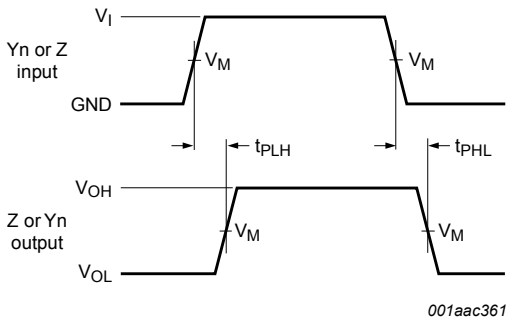
Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit circuit see Figure 17.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t_{pd}	propagation delay	Z to Yn or Yn to Z; see Figure 15 [2] [3]						
		V_{CC} = 1.65 V to 1.95 V	-	-	2	-	2.5	ns
		V_{CC} = 2.3 V to 2.7 V	-	-	1.2	-	1.5	ns
		V_{CC} = 2.7 V	-	-	1.0	-	1.25	ns
		V_{CC} = 3.0 V to 3.6 V	-	-	0.8	-	1.0	ns
		V_{CC} = 4.5 V to 5.5 V	-	-	0.6	-	0.8	ns
t_{en}	enable time	S to Z or Yn; see Figure 16 [2]						
		V_{CC} = 1.65 V to 1.95 V	2.6	6.7	10.3	2.6	12.9	ns
		V_{CC} = 2.3 V to 2.7 V	1.9	4.1	6.4	1.9	8.0	ns
		V_{CC} = 2.7 V	1.9	4.0	5.5	1.8	7.0	ns
		V_{CC} = 3.0 V to 3.6 V	1.8	3.4	5.0	1.8	6.3	ns
		V_{CC} = 4.5 V to 5.5 V	1.3	2.6	3.8	1.3	4.8	ns
		$\overline{E}$ to Z or Yn; see Figure 16 [2]						
		V_{CC} = 1.65 V to 1.95 V	1.9	4.0	7.3	1.9	9.2	ns
		V_{CC} = 2.3 V to 2.7 V	1.4	2.5	4.4	1.4	5.5	ns
		V_{CC} = 2.7 V	1.1	2.6	3.9	1.1	4.9	ns
		V_{CC} = 3.0 V to 3.6 V	1.2	2.2	3.8	1.2	4.8	ns
		V_{CC} = 4.5 V to 5.5 V	1.0	1.7	2.6	1.0	3.3	ns
t_{dis}	disable time	S to Z or Yn; see Figure 16 [2]						
		V_{CC} = 1.65 V to 1.95 V	2.1	6.8	10.0	2.1	12.5	ns
		V_{CC} = 2.3 V to 2.7 V	1.4	3.7	6.1	1.4	7.7	ns
		V_{CC} = 2.7 V	1.4	4.9	6.2	1.4	7.8	ns
		V_{CC} = 3.0 V to 3.6 V	1.1	4.0	5.4	1.1	6.8	ns
		V_{CC} = 4.5 V to 5.5 V	1.0	2.9	3.8	1.0	4.8	ns
		$\overline{E}$ to Z or Yn; see Figure 16 [2]						
		V_{CC} = 1.65 V to 1.95 V	2.3	5.6	8.6	2.3	11.0	ns
		V_{CC} = 2.3 V to 2.7 V	1.2	3.2	4.8	1.2	6.0	ns
		V_{CC} = 2.7 V	1.4	4.0	5.2	1.4	6.5	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	3.7	5.0	2.0	6.3	ns
		V_{CC} = 4.5 V to 5.5 V	1.3	2.9	3.8	1.3	4.8	ns

[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC}.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{en} is the same as t_{PZH} and t_{PZL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}
[3] Propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified capacitance when driven by an ideal voltage source (zero output impedance).

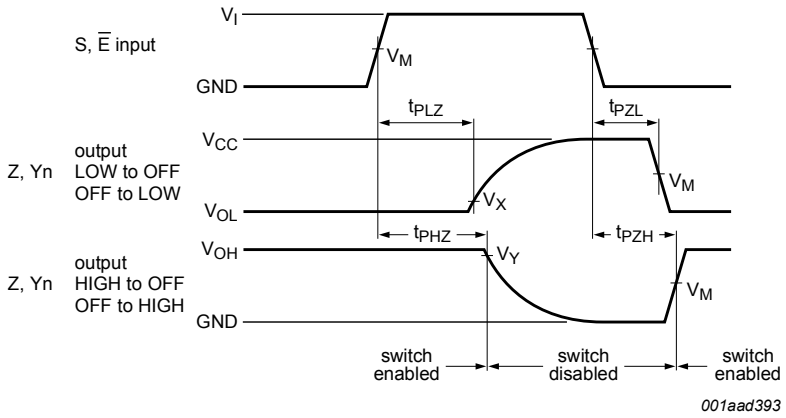
11.1 Waveforms and test circuits



Measurement points are given in Table 10.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 15. Input (Yn or Z) to output (Z or Yn) propagation delays



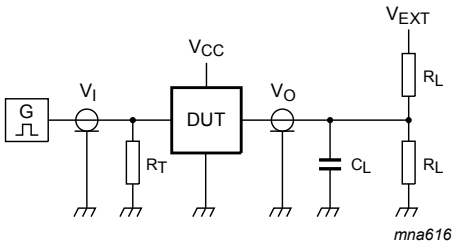
Measurement points are given in Table 10.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 16. Enable and disable times

Table 10. Measurement points

Supply voltage	Input	Output		
V_{CC}	V_M	V_M	V_X	V_Y
1.65 V to 2.7 V	0.5 x V_{CC}	0.5 x V_{CC}	V_{OL} + 0.15 V	V_{OH} - 0.15 V
2.7 V to 5.5 V	0.5 x V_{CC}	0.5 x V_{CC}	V_{OL} + 0.3 V	V_{OH} - 0.3 V



Test data is given in Table 11.

Definitions test circuit:

R_T = Termination resistance (should be equal to output impedance Z_o of the pulse generator).

C_L = Load capacitance (including jig and probe capacitance).

R_L = Load resistance.

V_{EXT} = External voltage for measuring switching times.

Figure 17. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	t_r, t_f	C_L	R_L	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
1.65 V to 1.95 V	V_{CC}	≤ 2.0 ns	30 pF	1 kΩ	open	GND	2 × V_{CC}
2.3 V to 2.7 V	V_{CC}	≤ 2.0 ns	30 pF	500 Ω	open	GND	2 × V_{CC}
2.7 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2 × V_{CC}
3 V to 3.6 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2 × V_{CC}
4.5 V to 5.5 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2 × V_{CC}

11.2 Additional dynamic characteristics

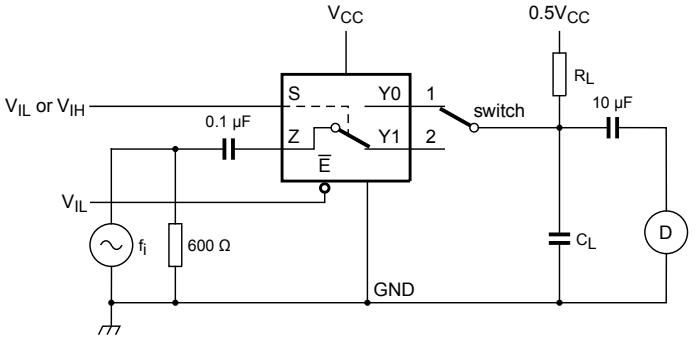
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T_{amb} = 25 °C.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
THD	total harmonic distortion	f_i = 600 Hz to 20 kHz; R_L = 600 Ω; C_L = 50 pF; V_I = 0.5 V (p-p); see Figure 18				
		V_{CC} = 1.65 V	-	0.260	-	%
		V_{CC} = 2.3 V	-	0.078	-	%
		V_{CC} = 3.0 V	-	0.078	-	%
		V_{CC} = 4.5 V	-	0.078	-	%
$f_{(-3dB)}$	-3 dB frequency response	R_L = 50 Ω; C_L = 5 pF; see Figure 19				
		V_{CC} = 1.65 V	-	200	-	MHz
		V_{CC} = 2.3 V	-	300	-	MHz
		V_{CC} = 3.0 V	-	300	-	MHz
		V_{CC} = 4.5 V	-	300	-	MHz

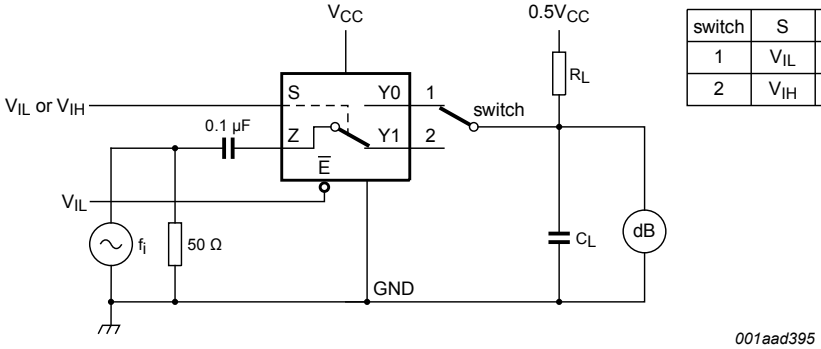
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
α_{iso}	isolation (OFF-state)	R_L = 50 Ω; C_L = 5 pF; f_i = 10 MHz; see Figure 20				
		V_{CC} = 1.65 V	-	-42	-	dB
		V_{CC} = 2.3 V	-	-42	-	dB
		V_{CC} = 3.0 V	-	-40	-	dB
		V_{CC} = 4.5 V	-	-40	-	dB
Q_{inj}	charge injection	C_L = 0.1 nF; V_{gen} = 0 V; R_{gen} = 0 Ω; f_i = 1 MHz; R_L = 1 MΩ; see Figure 21				
		V_{CC} = 1.8 V	-	3.3	-	pC
		V_{CC} = 2.5 V	-	4.1	-	pC
		V_{CC} = 3.3 V	-	5.0	-	pC
		V_{CC} = 4.5 V	-	6.4	-	pC
		V_{CC} = 5.5 V	-	7.5	-	pC

11.3 Test circuits



switch	S	$\overline{E}$
1	V_{IL}	V_{IL}
2	V_{IH}	V_{IL}

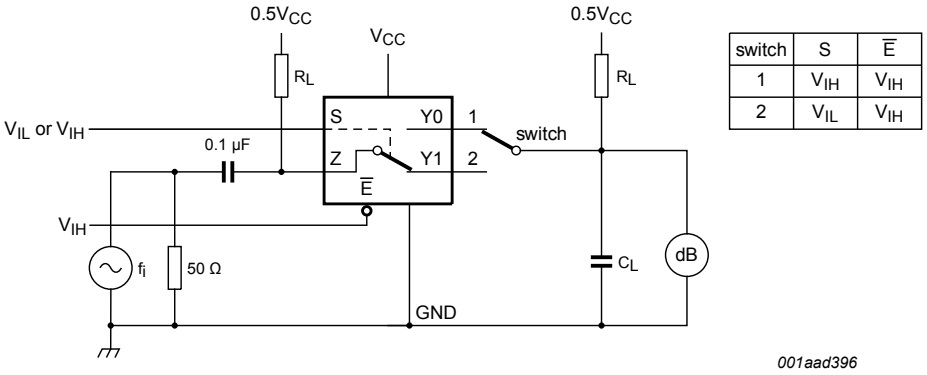
Figure 18. Test circuit for measuring total harmonic distortion



switch	S	$\overline{E}$
1	V_{IL}	V_{IL}
2	V_{IH}	V_{IL}

Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads -3 dB

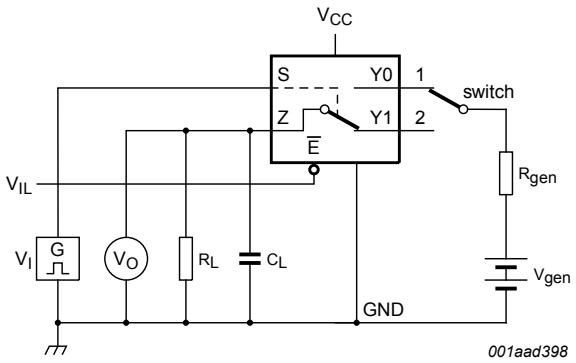
Figure 19. Test circuit for measuring the frequency response when switch is in ON-state



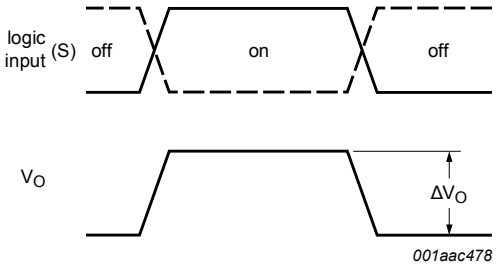
switch	S	$\overline{E}$
1	V_{IH}	V_{IH}
2	V_{IL}	V_{IH}

Adjust f_i voltage to obtain 0 dBm level at input

Figure 20. Test circuit for measuring isolation (OFF-state)



a. Test circuit



b. Input and output pulse definitions

$Q_{inj} = \Delta V_O \times C_L$

ΔV_O = output voltage variation

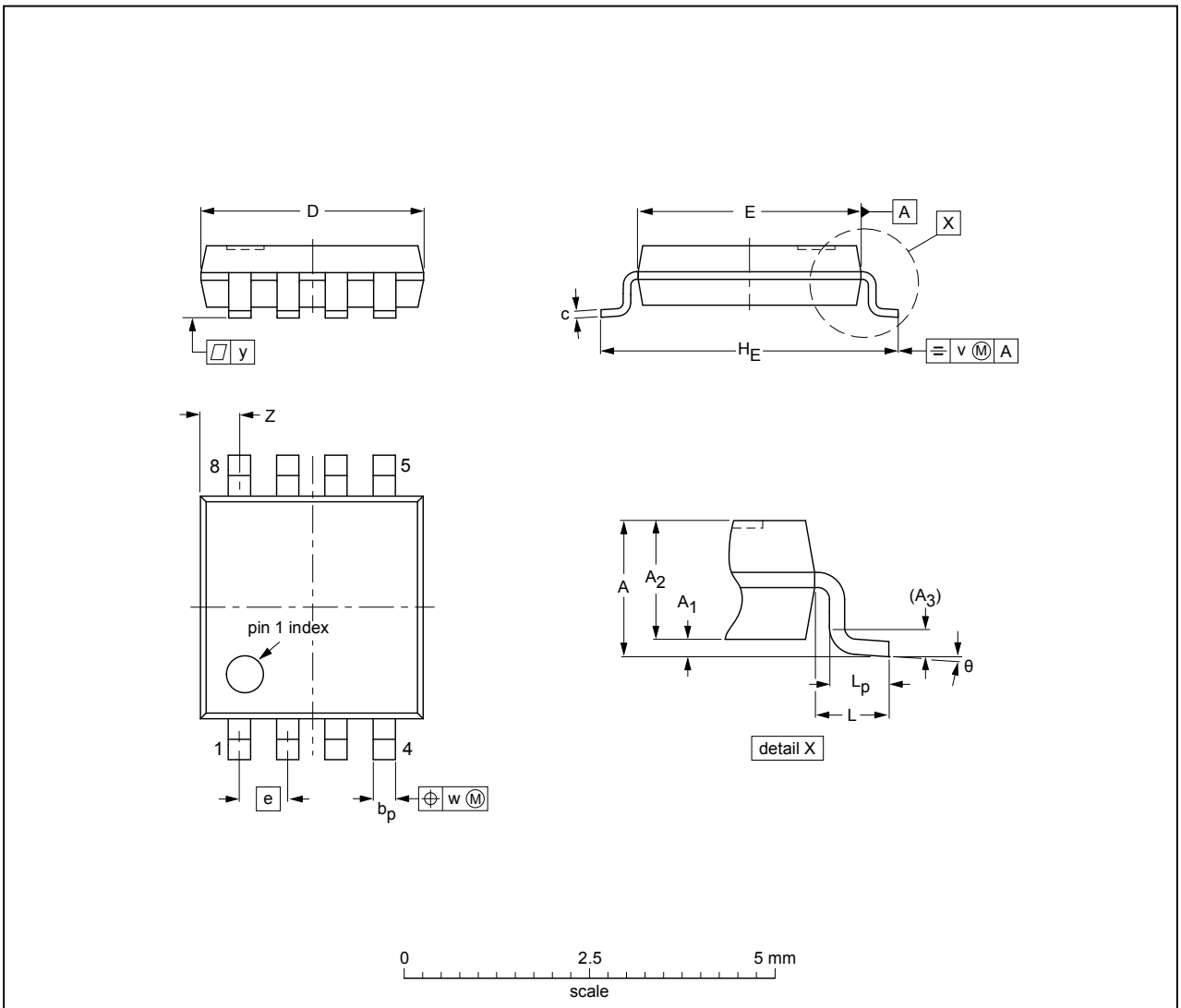
R_{gen} = generator resistance

V_{gen} = generator voltage

Figure 21. Test circuit for measuring charge injection

12 Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	v	w	y	$Z^{(1)}$	θ
mm	1.1	0.15 0.00	0.95 0.75	0.25	0.38 0.22	0.18 0.08	3.1 2.9	3.1 2.9	0.65	4.1 3.9	0.5	0.47 0.33	0.2	0.13	0.1	0.70 0.35	8° 0°

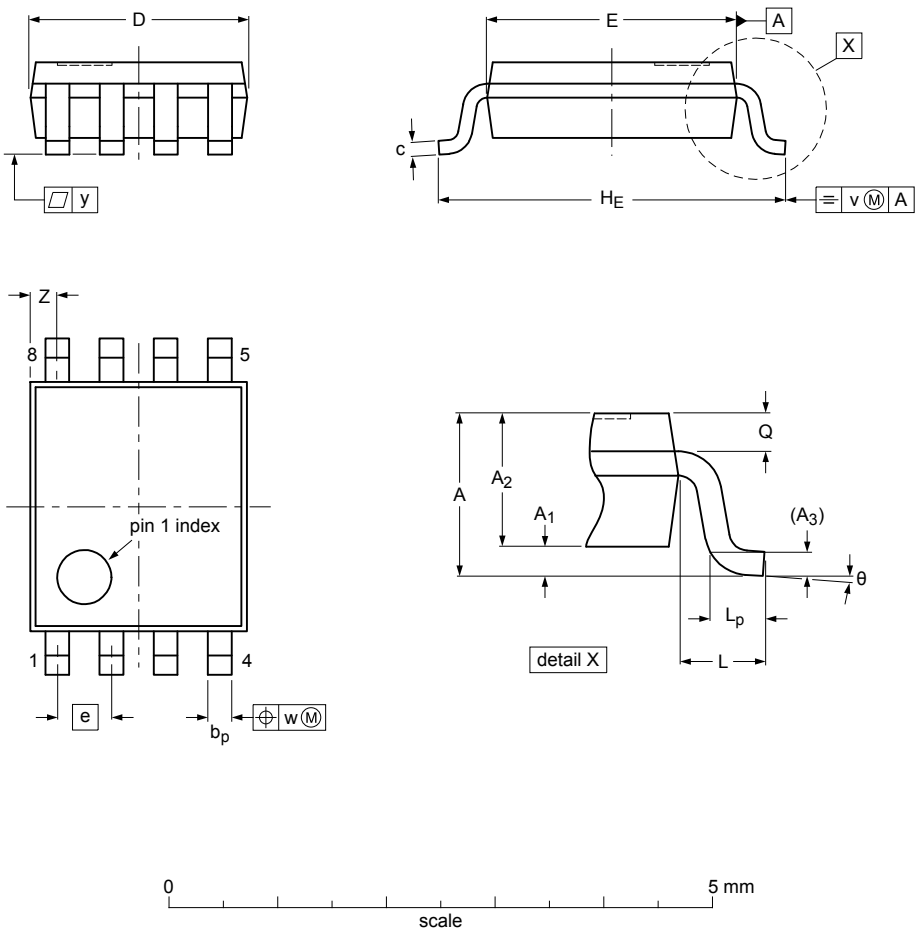
Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT505-2		- - -				02-01-16

Figure 22. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm **SOT765-1**



Dimensions (mm are the original dimensions)

Unit	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
max		0.15	0.85		0.27	0.23	2.1	2.4		3.2		0.40	0.21				0.4	8°
mm nom	1			0.12					0.5		0.4			0.2	0.08	0.1		
min		0.00	0.60		0.17	0.08	1.9	2.2		3.0		0.15	0.19				0.1	0°

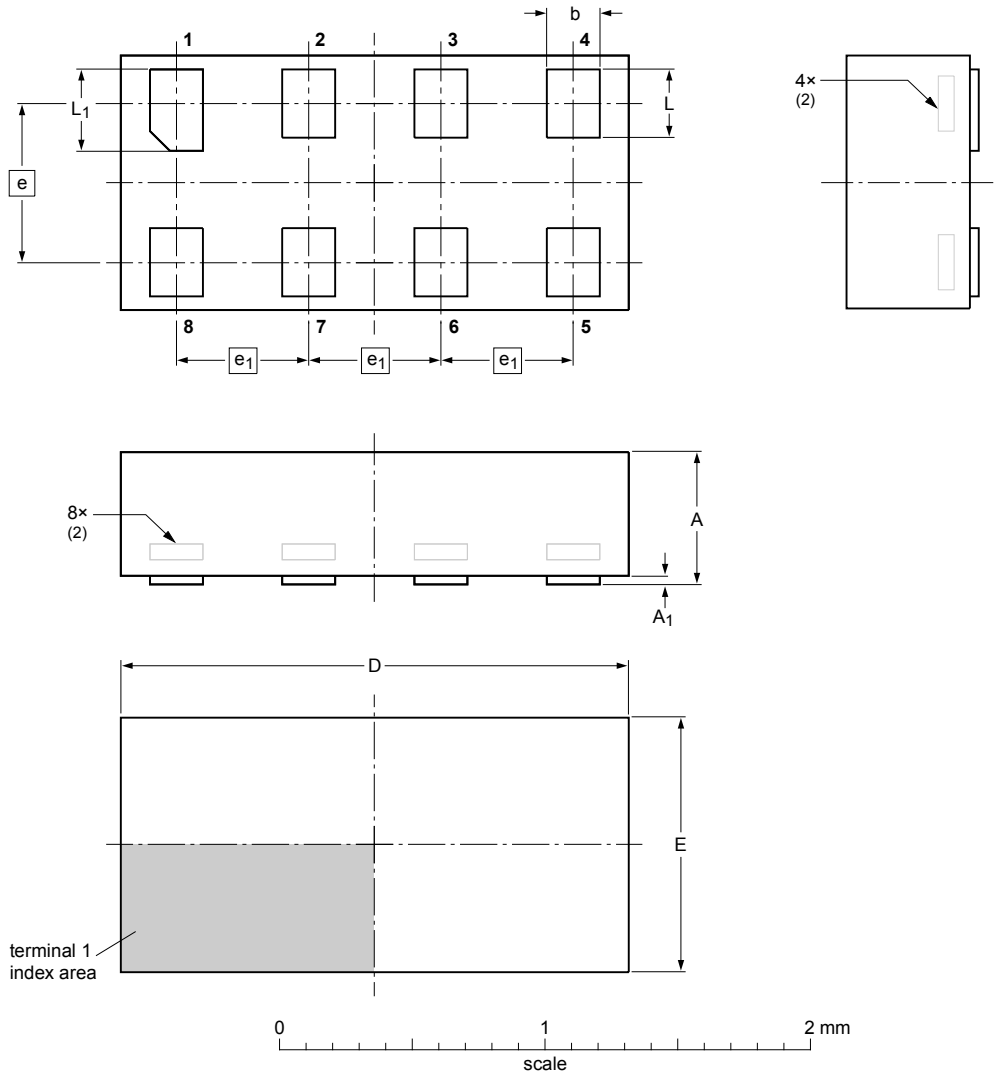
Note
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

sot765-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT765-1		MO-187				~~07-06-02~~ 16-05-31

Figure 23. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm **SOT833-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A(1) max	A_1 max	b	D	E	e	e_1	L	L_1
mm	0.5	0.04	0.25 0.17	2.0 1.9	1.05 0.95	0.6	0.5	0.35 0.27	0.40 0.32

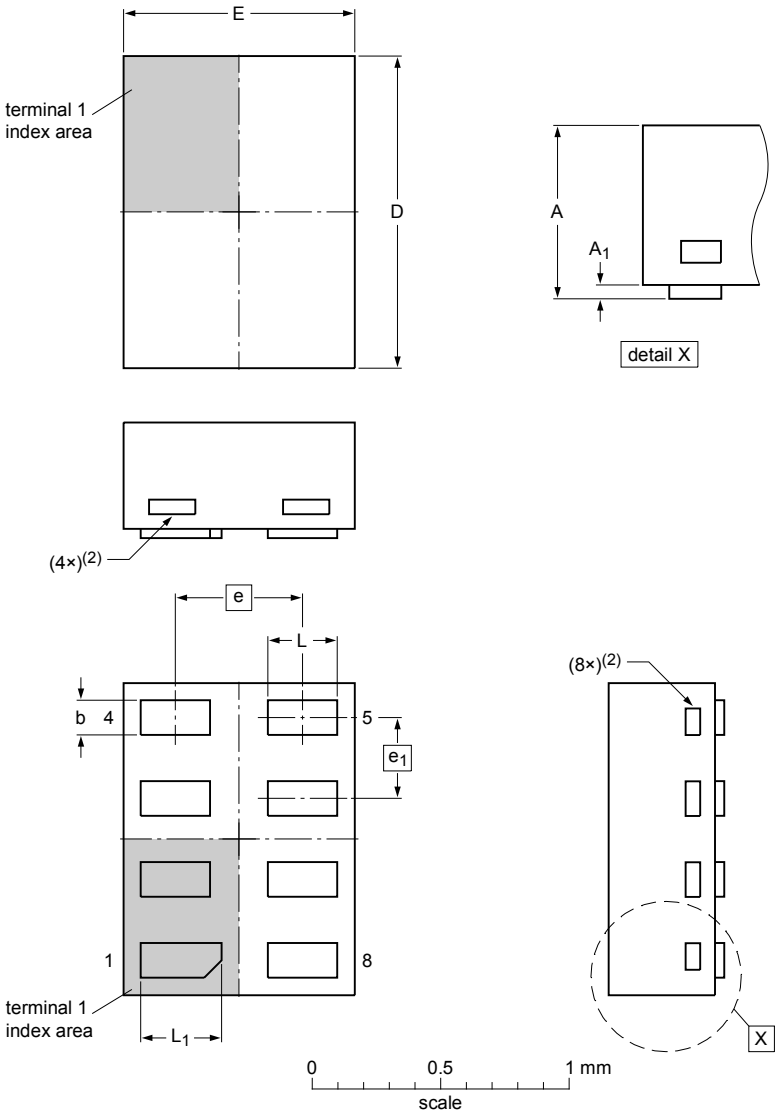
Notes

1. Including plating thickness.
2. Can be visible in some manufacturing processes.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT833-1	- - -	MO-252	- - -			~~07-11-14~~ 07-12-07

Figure 24. Package outline SOT833-1 (XSON8)

XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm **SOT1089**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.5	0.04	0.20	1.40	1.05			0.35	0.40
	nom			0.15	1.35	1.00	0.55	0.35	0.30	0.35
	min			0.12	1.30	0.95			0.27	0.32

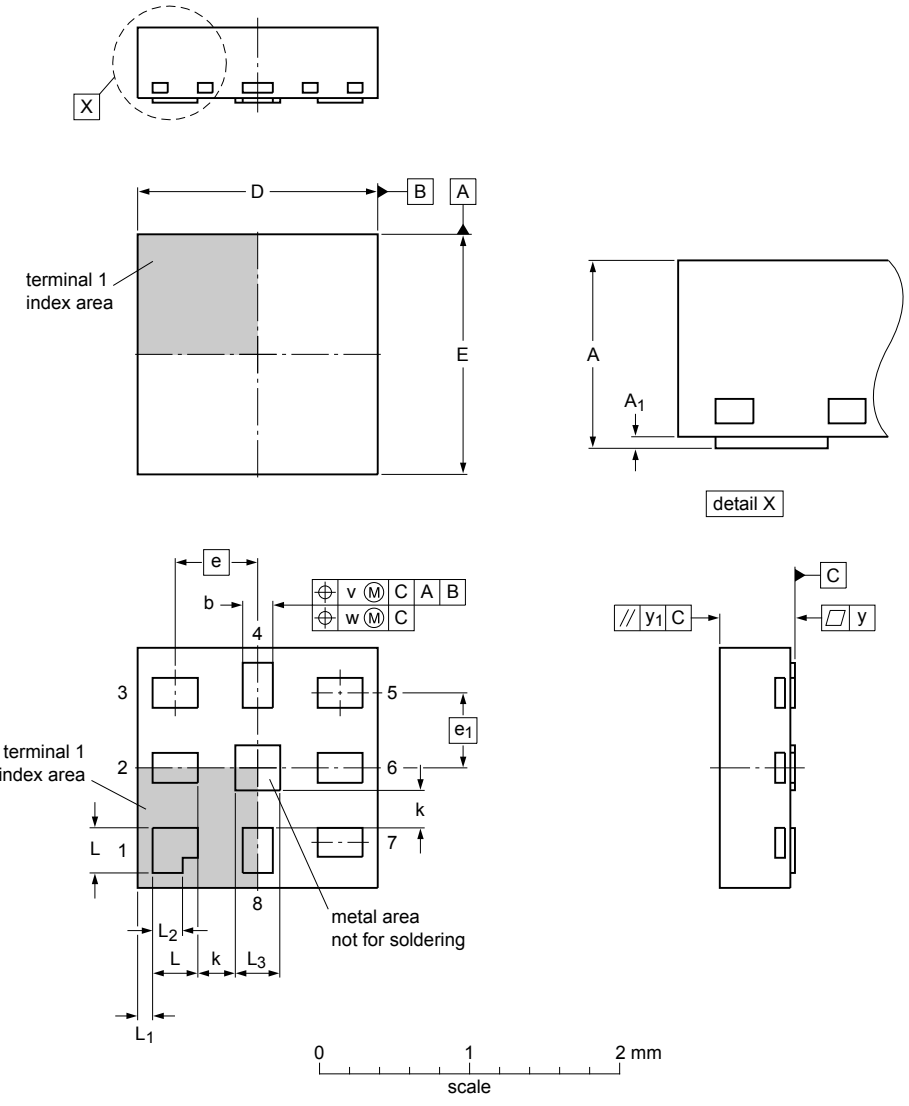
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1089_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1089		MO-252				~~10-04-09~~ 10-04-12

Figure 25. Package outline SOT1089 (XSON8)

XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm **SOT902-2**



Dimensions

Unit[1]		A	A_1	b	D	E	e	e_1	k	L	L_1	L_2	L_3	v	w	y	y_1
mm	max	0.5	0.05	0.25	1.65	1.65				0.35	0.15	0.25	0.35				
	nom			0.20	1.60	1.60	0.55	0.5		0.30	0.10	0.20	0.30	0.1	0.05	0.05	0.05
	min		0.00	0.15	1.55	1.55			0.2	0.25	0.05	0.15	0.25				

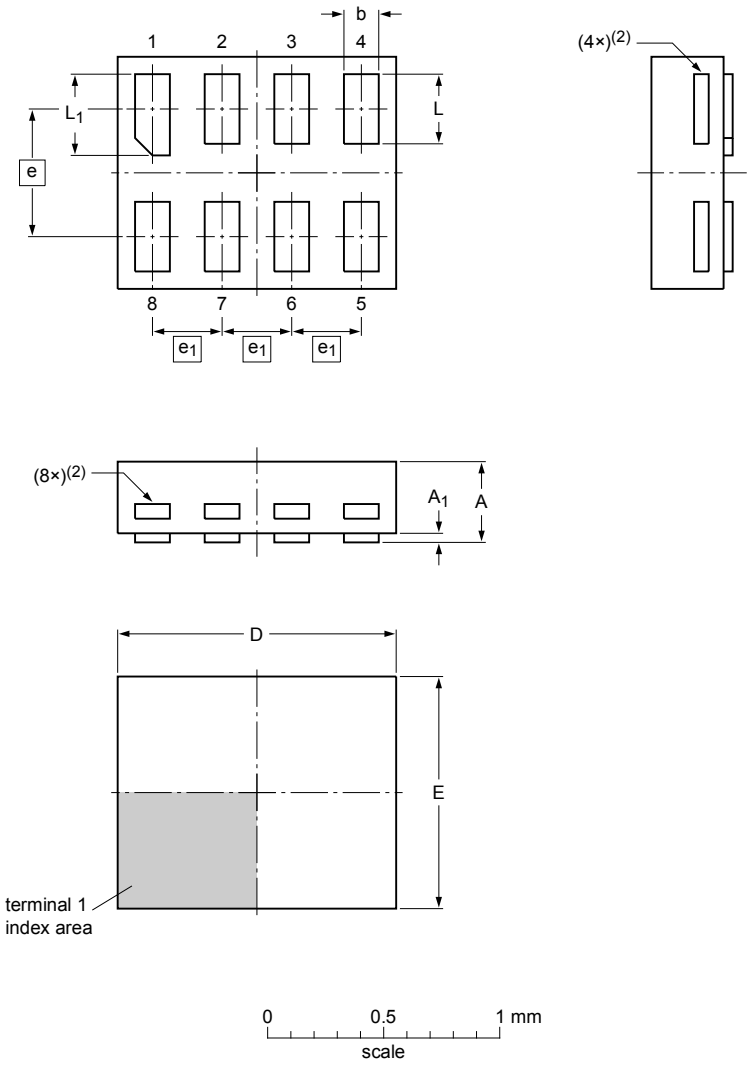
Note
1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

sot902-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT902-2	- - -	MO-255	- - -			~~16-07-14~~ 16-11-08

Figure 26. Package outline SOT902-2 (XQFN8)

XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm **SOT1116**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	1.25	1.05			0.35	0.40
	nom			0.15	1.20	1.00	0.55	0.3	0.30	0.35
	min			0.12	1.15	0.95			0.27	0.32

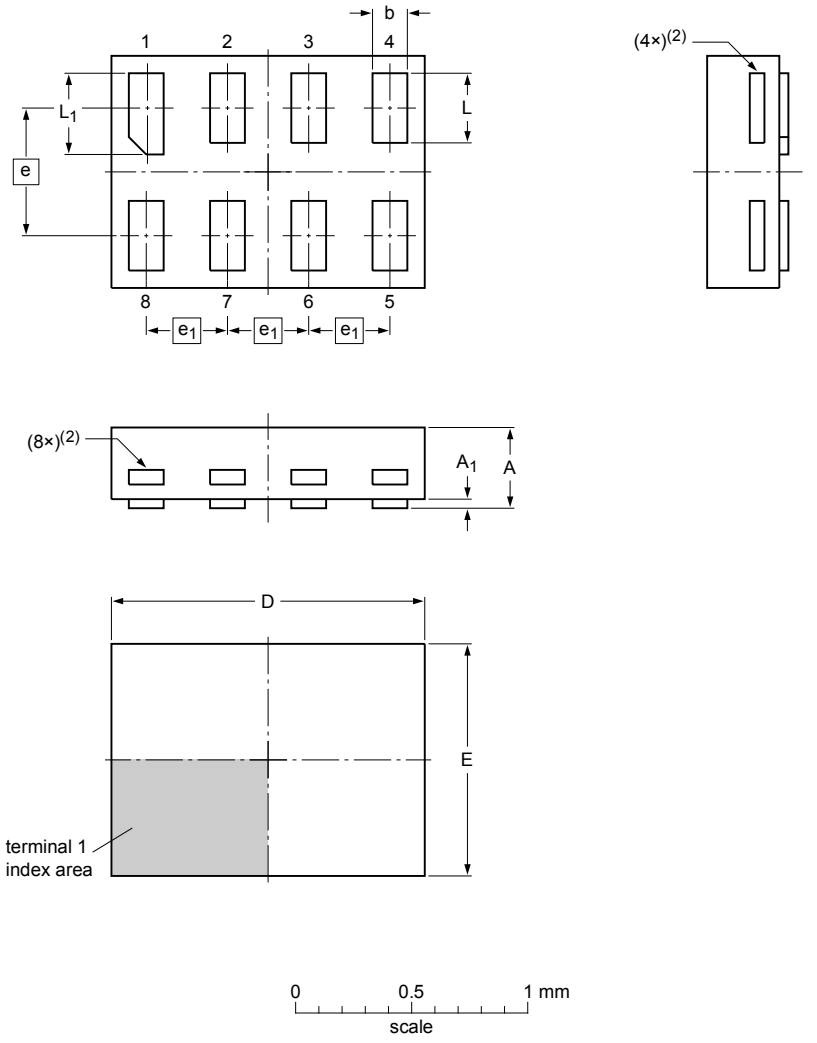
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1116_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1116						~~10-04-02~~ 10-04-07

Figure 27. Package outline SOT1116 (XSON8)

XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm **SOT1203**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	1.40	1.05			0.35	0.40
	nom			0.15	1.35	1.00	0.55	0.35	0.30	0.35
	min			0.12	1.30	0.95			0.27	0.32

Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1203_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1203						~~10-04-02~~ 10-04-06

Figure 28. Package outline SOT1203 (XSON8)

13 Abbreviations

Table 13. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
TTL	Transistor-Transistor Logic
HBM	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
CDM	Charged Device Model
DUT	Device Under Test

14 Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G53 v.11	20180116	Product data sheet	-	74LVC1G53 v.10
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Type number 74LVC1G53GD (SOT996-2 / XSON8) removed.			
74LVC1G53 v.10	20161207	Product data sheet	-	74LVC1G53 v.9
Modifications:	• Table 7: The maximum limits for leakage current and supply current have changed.			
74LVC1G53 v.9	20130405	Product data sheet	-	74LVC1G53 v.8
Modifications:	• For type number 74LVC1G53GD XSON8U has changed to XSON8.			
74LVC1G53 v.8	20120622	Product data sheet	-	74LVC1G53 v.7
Modifications:	• For type number 74LVC1G53GM the SOT code has changed to SOT902-2.			
74LVC1G53 v.7	20111206	Product data sheet	-	74LVC1G53 v.6
Modifications:	• Legal pages updated.			
74LVC1G53 v.6	20100621	Product data sheet	-	74LVC1G53 v.5
74LVC1G53 v.5	20080611	Product data sheet	-	74LVC1G53 v.4
74LVC1G53 v.4	20080303	Product data sheet	-	74LVC1G53 v.3
74LVC1G53 v.3	20070829	Product data sheet	-	74LVC1G53 v.2
74LVC1G53 v.2	20060410	Product data sheet	-	74LVC1G53 v.1
74LVC1G53 v.1	20060110	Product data sheet	-	-

15 Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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